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DAP[®] 4000[®] SUBFLOOR Construction Adhesive

Plann. 10 C

is a premium grade solvent construction adhesive specifically formulated for subfloor and deck installation. Using this easy-to-gun, solvent-based adhesive during the installation process prevents floor squeaks and improves the structural performance of the floor assembly.

SOLVENT FORMULA

BONDS WET, FROZEN & TREATED LUMBER

MEETS / EXCEEDS ASTM D3498

PREVENTS FLOOR SQUEAKS



VPORS MAY CAUSE FLASS IFFLASS INFORMATION OF REU SINLINVED. Read back panel carefully for der an PELICROT VAPORY VI LOUIDO EXTREMNANDER NEUMABLES. LOS VAPORES PUEDEN CAUSAN RE NEUMABLES. LOS VAPORES PUEDEN CAUSAN RE NEUMASIMENTE Janel posterior softer des precisi 28 FL OZ (828 mL)

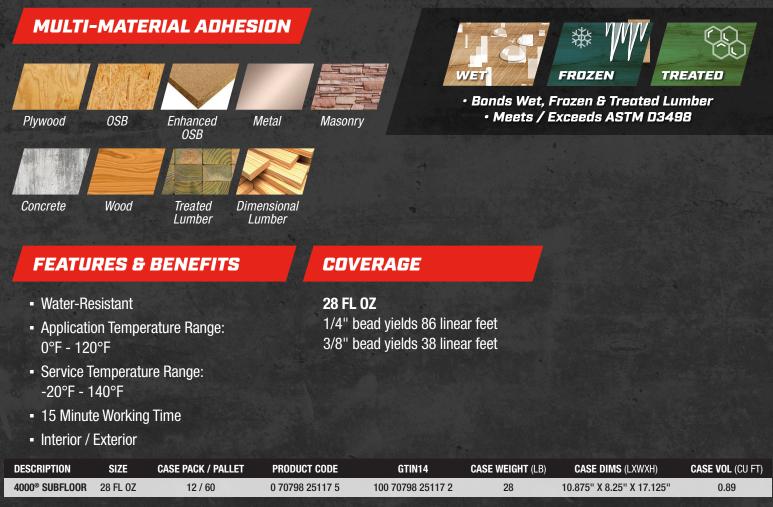
4000" SUBFLOOR

SOLVENT FORMULA

SUBFLOOR · WOOD-TO-WOOD ASSEMBLIES · GLUED FLOOR SYSTEMS · DECK INSTALLATION



PREVENTS FLOOR SQUEAKS & IMPROVES STRUCTURAL PERFORMANCE



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